MOSFET – Power, N-Channel, SO-8 30 V, 11 A

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Disk Drives
- DC-DC Converters
- Printers

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

Param			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	30	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady	T _A = 25°C	I _D	9.0	А
Current R _{0JA} (Note 1)	State	T _A = 70°C	1	7.2	
Power Dissipation $R_{\theta JA}$ (Note 1)	Steady State	$T_A = 25^{\circ}C$	P _D	1.37	W
Continuous Drain	Steady	T _A = 25°C	I _D	6.8	А
Current R _{θJA} (Note 2)	State	$T_A = 70^{\circ}C$		5.4	
Power Dissipation $R_{\theta JA}$ (Note 2)		$T_A = 25^{\circ}C$	P _D	0.78	W
Continuous Drain	Steady	T _A = 25°C	Ι _D	11	А
Current $R_{\theta JA}$, t \leq 10 s (Note 1)	State	T _A = 70°C		8.8	
Power Dissipation $R_{\theta JA}$, t \leq 10 s(Note 1)	Steady State	$T_A = 25^{\circ}C$	P _D	2.04	W
Pulsed Drain Current	T _A = 25°C, t _p = 10 μs		I _{DM}	33	А
Operating Junction and Storage Temperature			Т _Ј , T _{stg}	–55 to 150	°C
Source Current (Body Diode)			۱ _S	2.7	А
Single Pulse Drain-to-Source Avalanche Energy ($T_J = 25^{\circ}C$, $V_{DD} = 30$ V, $V_{GS} = 10$ V, $I_L = 12.5 A_{pk}$, $L = 1.0 \text{ mH}$, $R_G = 25 \Omega$)			E _{AS}	78	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	91.5	°C/W
Junction-to-Ambient $-t \le 10 \text{ s}$ (Note 1)	$R_{\theta JA}$	61.3	
Junction-to-Foot (Drain)	$R_{\theta JF}$	22.5	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	159.5	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

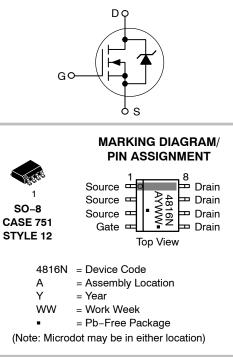


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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	10 m Ω @ 10 V	11 A
30 V	16 m Ω @ 4.5 V	

N-Channel



ORDERING INFORMATION

	Device	Package	Shipping [†]
I	NTMS4816NR2G	SO-8 (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

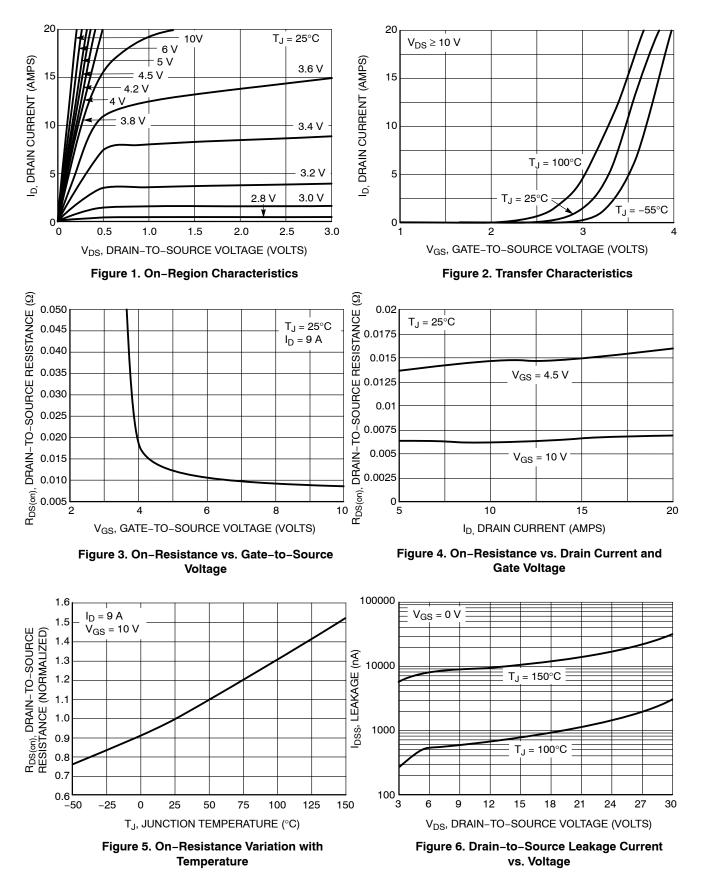
- Surfacemounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).
 Surfacemounted on FR4 board using the minimum recommended pad size.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

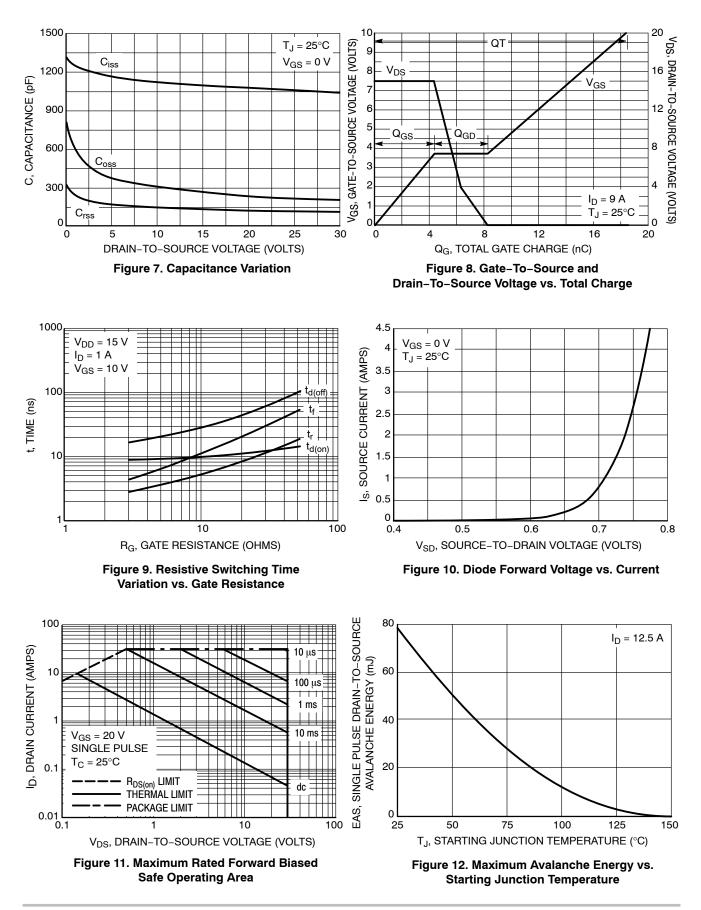
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS		•			-		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_{D} = 2$	50 μΑ	30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				26		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}		T _J = 25°C			1.0	μΑ
		V_{GS} = 0 V, V_{DS} = 24 V	T _J = 100°C			10	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} =				±100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 2$	250 μA	1.5		3.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				6.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D =	= 9 A		8.2	10	mΩ
		V _{GS} = 4.5 V, I _D =	7.2 A		12.7	16	
Forward Transconductance	9 _{FS}	V _{DS} = 1.5 V, I _D =	= 9 A		26		S
CHARGES, CAPACITANCES AND GA	ATE RESISTAN	ICE					
Input Capacitance	C _{iss}				1060		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MHz	, V _{DS} = 25 V		220		
Reverse Transfer Capacitance	C _{rss}				126		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 15 V, I _D = 9 A			9.2		nC
Threshold Gate Charge	Q _{G(TH)}				2.4		
Gate-to-Source Charge	Q _{GS}				4.4		
Gate-to-Drain Charge	Q _{GD}				3.8		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 15	V, I _D = 9 A		18.3		nC
SWITCHING CHARACTERISTICS (No	ote 4)				1		
Turn-On Delay Time	t _{d(on)}				8.0		ns
Rise Time	tr	V _{GS} = 10 V, V _{DS} =	= 15 V.		3.8		
Turn-Off Delay Time	t _{d(off)}	$I_{\rm D} = 1.0 \text{ A}, \text{ R}_{\rm G} =$			21.6		
Fall Time	t _f		·		8.0		
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V _{SD}		$T_J = 25^{\circ}C$		0.75	1.0	V
		V_{GS} = 0 V, I _S = 2.7 A	T _J = 125°C		0.55		
Reverse Recovery Time	t _{RR}				20		ns
Charge Time	t _a	V_{GS} = 0 V, d_{IS}/d_{t} = 100 A/µs, I_{S} = 2.7 A			9.0		1
Discharge Time	t _b				11		1
Reverse Recovery Charge	Q _{RR}				9.0		nC
PACKAGE PARASITIC VALUES							
Source Inductance	L _S	$T_A = 25^{\circ}C$			0.66		nH
Drain Inductance	L _D	T _A = 25°C			0.20		nH
Gate Inductance	L _G	T _A = 25°C			1.5		nH
Gate Resistance	R _G	T _A = 25°C			1.5	2.3	Ω

 $\begin{array}{ll} \mbox{3. Pulse Test: pulse width = 300 μs, duty cycle $\le 2\%$.} \\ \mbox{4. Switching characteristics are independent of operating junction temperatures.} \end{array}$

TYPICAL PERFORMANCE CURVES



TYPICAL PERFORMANCE CURVES



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*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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STYLE 1: PIN 1. EMITTER COLLECTOR 2. COLLECTOR 3. 4. EMITTER 5. EMITTER BASE 6. 7 BASE EMITTER 8. STYLE 5: PIN 1. DRAIN 2. DRAIN З. DRAIN DRAIN 4. GATE 5. 6. GATE SOURCE 7. 8. SOURCE STYLE 9: PIN 1. EMITTER, COMMON COLLECTOR, DIE #1 COLLECTOR, DIE #2 2. З. EMITTER, COMMON 4. 5. EMITTER, COMMON 6 BASE. DIE #2 BASE, DIE #1 7. 8. EMITTER, COMMON STYLE 13: PIN 1. N.C. 2. SOURCE 3 GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 17: PIN 1. VCC 2. V2OUT V10UT З. TXE 4. 5. RXE 6. VFF 7. GND 8. ACC STYLE 21: PIN 1. CATHODE 1 2. CATHODE 2 3 CATHODE 3 CATHODE 4 4. 5. CATHODE 5 6. COMMON ANODE COMMON ANODE 7. 8. CATHODE 6 STYLE 25: PIN 1. VIN 2 N/C REXT З. 4. GND 5. IOUT 6. IOUT IOUT 7. 8. IOUT STYLE 29: BASE, DIE #1 PIN 1. 2 EMITTER, #1 BASE, #2 З. EMITTER, #2 4. 5 COLLECTOR, #2 COLLECTOR, #2 6.

STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 COLLECTOR, #2 3. 4 COLLECTOR, #2 BASE, #2 5. EMITTER, #2 6. 7 BASE #1 EMITTER, #1 8. STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN SOURCE 4. SOURCE 5. 6. GATE GATE 7. 8. SOURCE STYLE 10: GROUND PIN 1. BIAS 1 OUTPUT 2. З. GROUND 4. 5. GROUND 6 BIAS 2 INPUT 7. 8. GROUND STYLE 14: PIN 1. N-SOURCE 2. N-GATE 3 P-SOURCE P-GATE 4. P-DRAIN 5 6. P-DRAIN N-DRAIN 7. N-DRAIN 8. STYLE 18: PIN 1. ANODE ANODE 2. SOURCE 3. GATE 4. 5. DRAIN 6 DRAIN CATHODE 7. 8. CATHODE STYLE 22: PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC 3 COMMON CATHODE/VCC 4. I/O LINE 3 COMMON ANODE/GND 5. 6. I/O LINE 4 7. I/O LINE 5 8. COMMON ANODE/GND STYLE 26: PIN 1. GND 2 dv/dt З. ENABLE 4. ILIMIT 5. SOURCE SOURCE 6. SOURCE 7. 8. VCC STYLE 30: DRAIN 1 PIN 1. DRAIN 1 2 GATE 2 З. SOURCE 2 4. SOURCE 1/DRAIN 2 SOURCE 1/DRAIN 2 5. 6.

STYLE 3: PIN 1. DRAIN, DIE #1 DRAIN, #1 2. DRAIN, #2 З. DRAIN, #2 4. GATE, #2 5. SOURCE, #2 6. 7 GATE #1 8. SOURCE, #1 STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS THIRD STAGE SOURCE GROUND З. 4. 5. DRAIN 6. GATE 3 SECOND STAGE Vd 7. FIRST STAGE Vd 8. STYLE 11: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. DRAIN 2 DRAIN 1 7. 8. DRAIN 1 STYLE 15: PIN 1. ANODE 1 2. ANODE 1 ANODE 1 3 ANODE 1 4. 5. CATHODE, COMMON CATHODE, COMMON CATHODE, COMMON 6. 7. CATHODE, COMMON 8. STYLE 19: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. MIRROR 2 7. DRAIN 1 8. **MIRROR 1** STYLE 23: PIN 1. LINE 1 IN COMMON ANODE/GND COMMON ANODE/GND 2. 3 LINE 2 IN 4. LINE 2 OUT 5. COMMON ANODE/GND COMMON ANODE/GND 6. 7. 8. LINE 1 OUT STYLE 27: PIN 1. ILIMIT 2 OVI 0 UVLO З. 4. INPUT+ 5. 6. SOURCE SOURCE SOURCE 7. 8 DRAIN

STYLE 4: PIN 1. 2. ANODE ANODE ANODE З. 4. ANODE ANODE 5. 6. ANODE 7 ANODE COMMON CATHODE 8. STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 BASE #2 З. COLLECTOR, #2 4. COLLECTOR, #2 5. 6. EMITTER, #2 EMITTER, #1 7. 8. COLLECTOR, #1 STYLE 12: PIN 1. SOURCE SOURCE 2. 3. GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 16 EMITTER, DIE #1 PIN 1. 2. BASE, DIE #1 EMITTER, DIE #2 3 BASE, DIE #2 4. 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 COLLECTOR, DIE #1 7. COLLECTOR, DIE #1 8. STYLE 20: PIN 1. SOURCE (N) GATE (N) SOURCE (P) 2. 3. 4. GATE (P) 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 24: PIN 1. BASE EMITTER 2. 3 COLLECTOR/ANODE COLLECTOR/ANODE 4. 5. CATHODE

6. CATHODE COLLECTOR/ANODE 7. 8. COLLECTOR/ANODE STYLE 28: PIN 1. SW_TO_GND 2. DASIC OFF DASIC_SW_DET З. 4. GND 5. 6. V MON VBULK 7. VBULK

7. VOULK 8. VIN

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SOURCE 1/DRAIN 2

7.

8. GATE 1

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7.

8

COLLECTOR, #1

COLLECTOR, #1

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